

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Franz Hirler	08/24/2011
Anton Mauder	08/22/2011
Hans-Joachim Schulze	08/22/2011
RECEIVING PARTY DATA	
Name:	Infineon Technologies Austria AG
Street Address:	Siemensstrasse 2
City:	Villach
State/Country:	AUSTRIA
Postal Code:	9500
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13205759
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	5497-341
NAME OF SUBMITTER:	Mark R. Bilak
Total Attachments: 2 source=5497-341_Assignment#page1.tif source=5497-341_Assignment#page2.tif	

OP \$40.00 13205759

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PATENT
REEL: 026889 FRAME: 0800

ASSIGNMENT

For good and valuable consideration, we,

Franz Hirler, a citizen of Germany, residing at Mozartstr. 4
D-84424 Isen, Germany,
Anton Mauder, a citizen of Germany, residing at Fabrikstraße 15a
83059 Kolbermoor, Germany,
Hans-Joachim Schulze, a citizen of Germany, residing at Finkenstrasse 21
82024 Taufkirchen, Germany,

hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to **Infineon Technologies Austria AG**, having its principal place of business at Siemensstrasse 2, 9500 Villach, Austria, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and

filed on August 9, 2011 US Serial No. 13/205759

entitled: **A Semiconductor Device and a Method for Forming a Semiconductor Device**

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

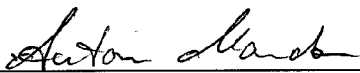
SIGNATURE: _____

Franz Hirler

DATE: _____

2011-08-24

CLIENT REF. 16493P-US /2011P50442US
C&B REF. 5497-341

SIGNATURE: 
Anton Mauder

DATE: 22nd August 2011

SIGNATURE: 
Hans-Joachim Schulze

DATE: 22nd August 2011